

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use <http://www.nexperia.com>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © **Nexperia B.V. (year). All rights reserved.**

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

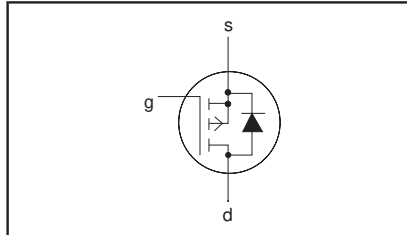
P-channel enhancement mode MOS transistor

BSH205

FEATURES

- Very low threshold voltage
- Fast switching
- Logic level compatible
- Subminiature surface mount package

SYMBOL



QUICK REFERENCE DATA

$$V_{DS} = -12 \text{ V}$$

$$I_D = -0.75 \text{ A}$$

$$R_{DS(ON)} \leq 0.5 \Omega \quad (V_{GS} = -2.5 \text{ V})$$

$$V_{GS(TO)} \geq 0.4 \text{ V}$$

GENERAL DESCRIPTION

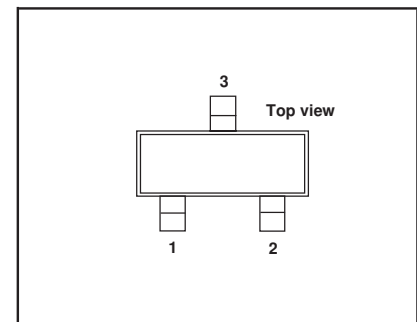
P-channel, enhancement mode, logic level, field-effect power transistor. This device has low threshold voltage and extremely fast switching making it ideal for battery powered applications and high speed digital interfacing.

The BSH205 is supplied in the SOT23 subminiature surface mounting package.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | gate |
| 2 | source |
| 3 | drain |

SOT23



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------------|----------------------------------|------------------------------------|------|---------|------------------|
| V_{DS} | Drain-source voltage | | - | -12 | V |
| V_{DGR} | Drain-gate voltage | $R_{GS} = 20 \text{ k}\Omega$ | - | -12 | V |
| V_{GS} | Gate-source voltage | | - | ± 8 | V |
| I_D | Drain current (DC) | $T_a = 25 \text{ }^\circ\text{C}$ | - | -0.75 | A |
| | | $T_a = 100 \text{ }^\circ\text{C}$ | - | -0.47 | A |
| I_{DM} | Drain current (pulse peak value) | $T_a = 25 \text{ }^\circ\text{C}$ | - | -3 | A |
| P_{tot} | Total power dissipation | $T_a = 25 \text{ }^\circ\text{C}$ | - | 0.417 | W |
| | | $T_a = 100 \text{ }^\circ\text{C}$ | - | 0.17 | W |
| T_{stg}, T_j | Storage & operating temperature | | -55 | 150 | $^\circ\text{C}$ |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|---------------|--|------------------------------|------|------|------|
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | FR4 board, minimum footprint | 300 | - | K/W |

P-channel enhancement mode
MOS transistor

BSH205

ELECTRICAL CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified

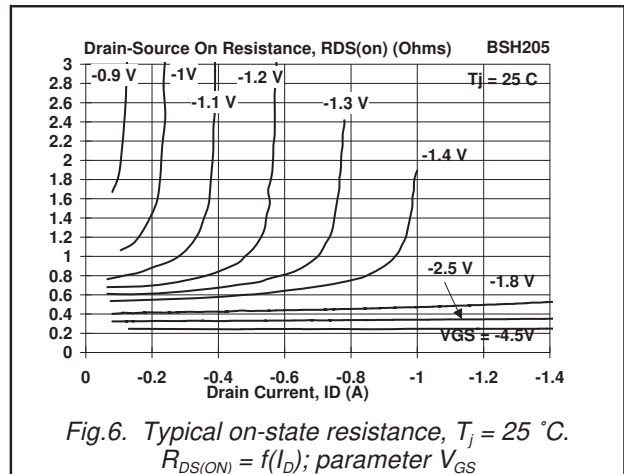
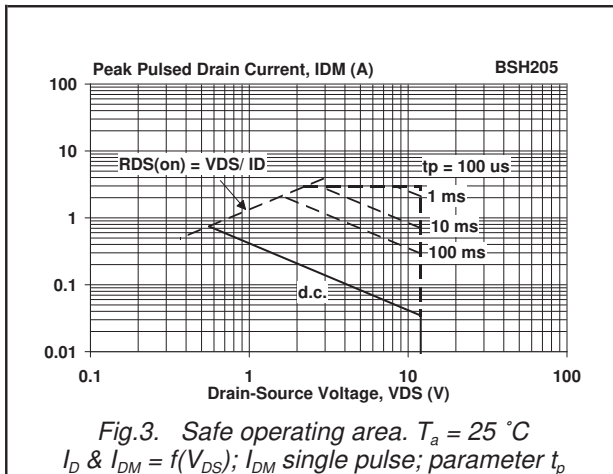
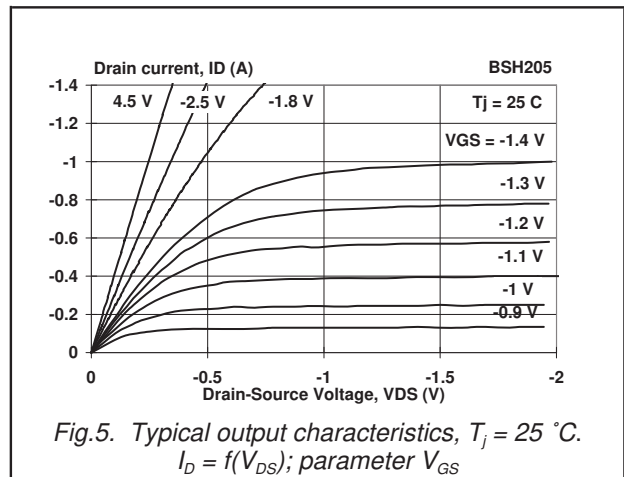
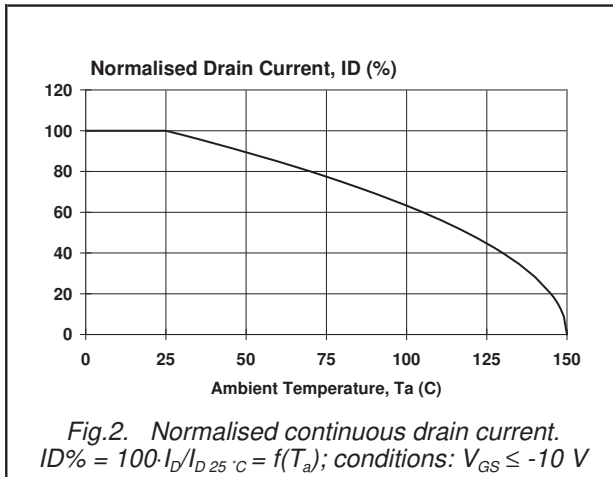
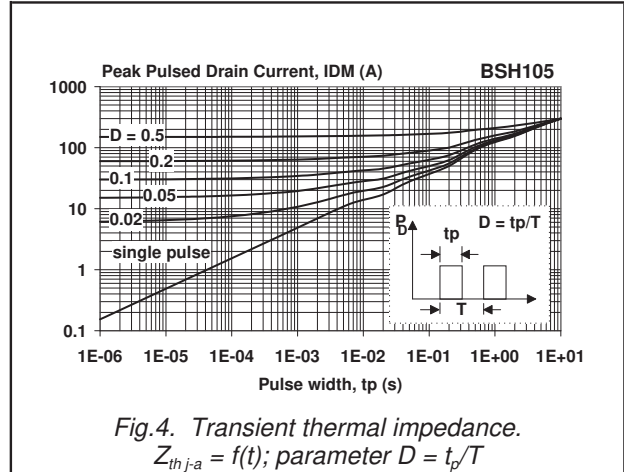
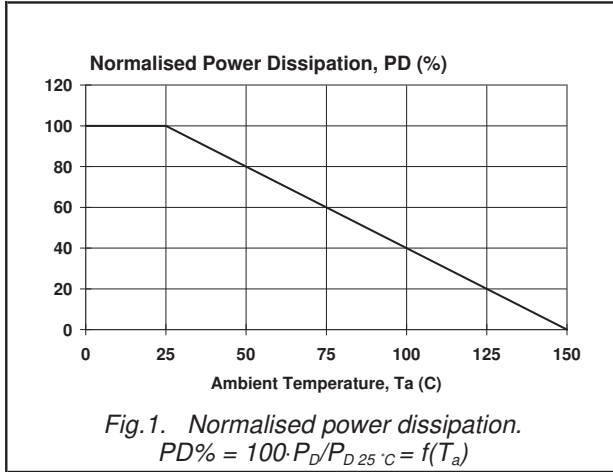
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|---|------|----------|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0\text{ V}; I_D = -10\ \mu\text{A}$ | -12 | - | - | V |
| $V_{GS(TO)}$ | Gate threshold voltage | $V_{DS} = V_{GS}; I_D = -1\ \text{mA}$ | -0.4 | -0.68 | - | V |
| $R_{DS(ON)}$ | Drain-source on-state resistance | $T_j = 150^\circ\text{C}$ | -0.1 | - | - | V |
| | | $V_{GS} = -4.5\ \text{V}; I_D = -430\ \text{mA}$ | - | 0.18 | 0.4 | Ω |
| | | $V_{GS} = -2.5\ \text{V}; I_D = -430\ \text{mA}$ | - | 0.32 | 0.5 | Ω |
| | | $V_{GS} = -1.8\ \text{V}; I_D = -210\ \text{mA}$ | - | 0.42 | 0.6 | Ω |
| g_{fs} | Forward transconductance | $V_{GS} = -2.5\ \text{V}; I_D = -430\ \text{mA}; T_j = 150^\circ\text{C}$ | - | 0.48 | 0.75 | Ω |
| I_{GSS} | Gate source leakage current | $V_{DS} = -9.6\ \text{V}; I_D = -430\ \text{mA}$ | 0.5 | 1.6 | - | S |
| I_{DSS} | Zero gate voltage drain current | $V_{GS} = \pm 8\ \text{V}; V_{DS} = 0\ \text{V}$ | - | ± 10 | ± 100 | nA |
| | | $V_{DS} = -9.6\ \text{V}; V_{GS} = 0\ \text{V}; T_j = 150^\circ\text{C}$ | - | -50 | -100 | nA |
| | | | - | -11 | -100 | μA |
| $Q_{g(tot)}$ | Total gate charge | $I_D = -0.5\ \text{A}; V_{DD} = -10\ \text{V}; V_{GS} = -4.5\ \text{V}$ | - | 3.8 | - | nC |
| Q_{gs} | Gate-source charge | | - | 0.4 | - | nC |
| Q_{gd} | Gate-drain (Miller) charge | | - | 1.0 | - | nC |
| $t_{d\ on}$ | Turn-on delay time | $V_{DD} = -10\ \text{V}; I_D = -0.5\ \text{A};$ | - | 2 | - | ns |
| t_r | Turn-on rise time | $V_{GS} = -8\ \text{V}; R_G = 6\ \Omega$ | - | 4.5 | - | ns |
| $t_{d\ off}$ | Turn-off delay time | Resistive load | - | 45 | - | ns |
| t_f | Turn-off fall time | | - | 20 | - | ns |
| C_{iss} | Input capacitance | $V_{GS} = 0\ \text{V}; V_{DS} = -9.6\ \text{V}; f = 1\ \text{MHz}$ | - | 200 | - | pF |
| C_{oss} | Output capacitance | | - | 95 | - | pF |
| C_{rss} | Feedback capacitance | | - | 41 | - | pF |

REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|----------------------------------|---|------|-------|-------|------|
| I_{DR} | Continuous reverse drain current | $T_a = 25^\circ\text{C}$ | - | - | -0.75 | A |
| I_{DRM} | Pulsed reverse drain current | | - | - | -3 | A |
| V_{SD} | Diode forward voltage | $I_F = -0.38\ \text{A}; V_{GS} = 0\ \text{V}$ | - | -0.72 | -1.3 | V |
| t_{rr} | Reverse recovery time | $I_F = -0.5\ \text{A}; -di_F/dt = 100\ \text{A}/\mu\text{s};$ | - | 75 | - | ns |
| Q_{rr} | Reverse recovery charge | $V_{GS} = 0\ \text{V}; V_R = -9.6\ \text{V}$ | - | 69 | - | nC |

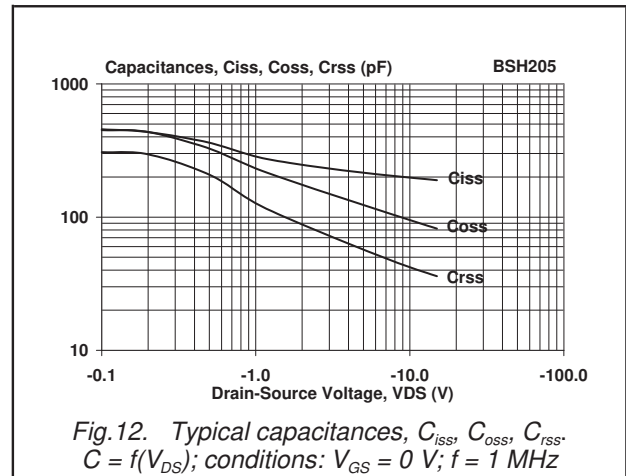
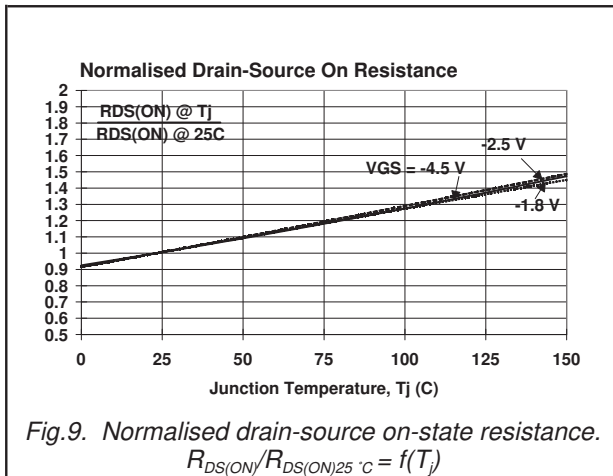
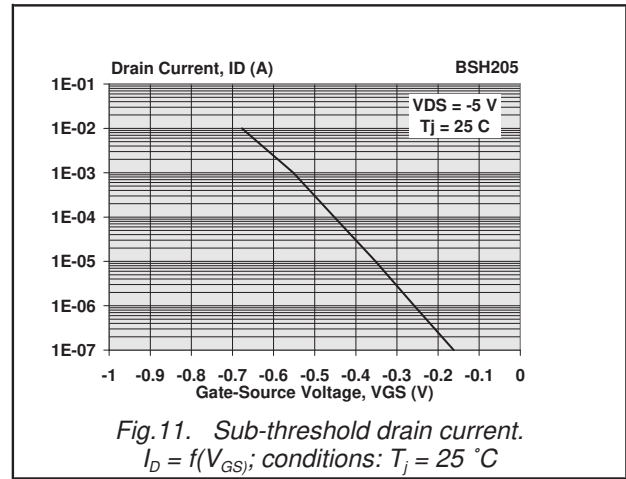
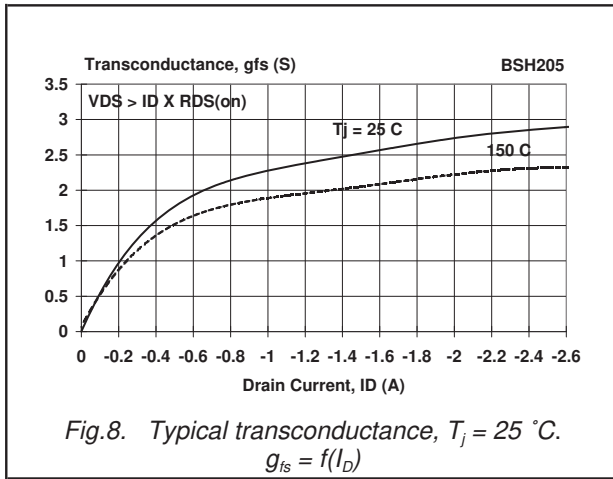
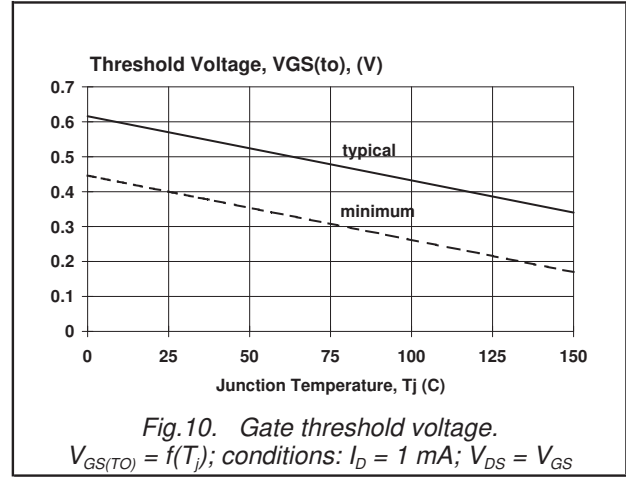
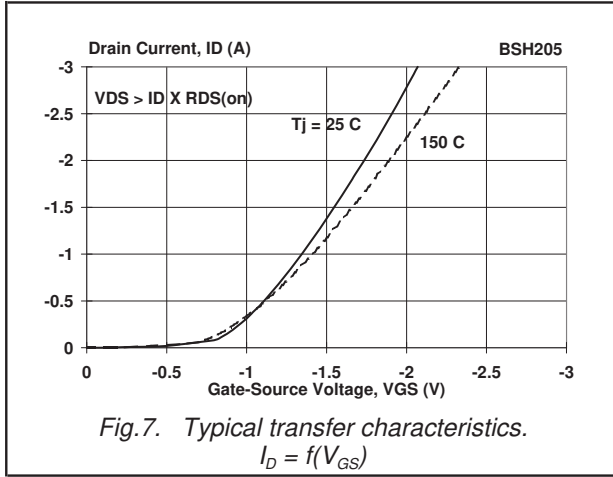
P-channel enhancement mode
MOS transistor

BSH205



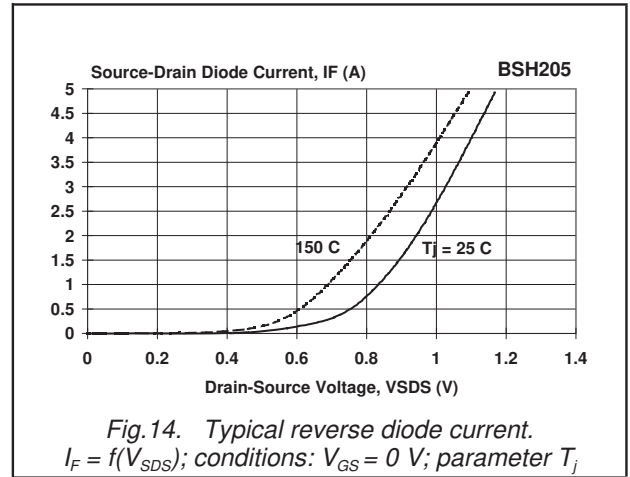
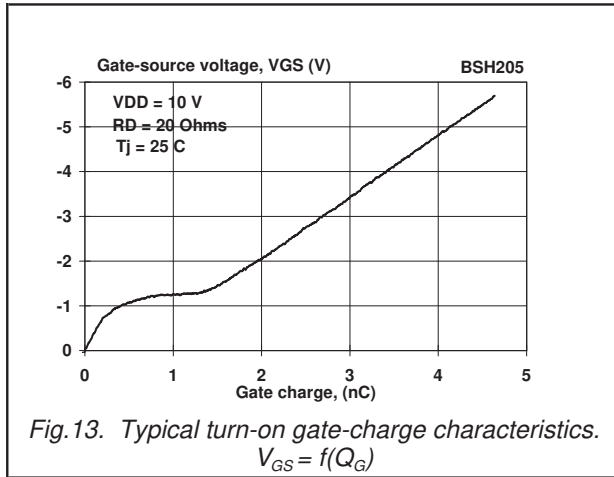
P-channel enhancement mode
MOS transistor

BSH205



P-channel enhancement mode
MOS transistor

BSH205



P-channel enhancement mode
MOS transistor

BSH205

MECHANICAL DATA

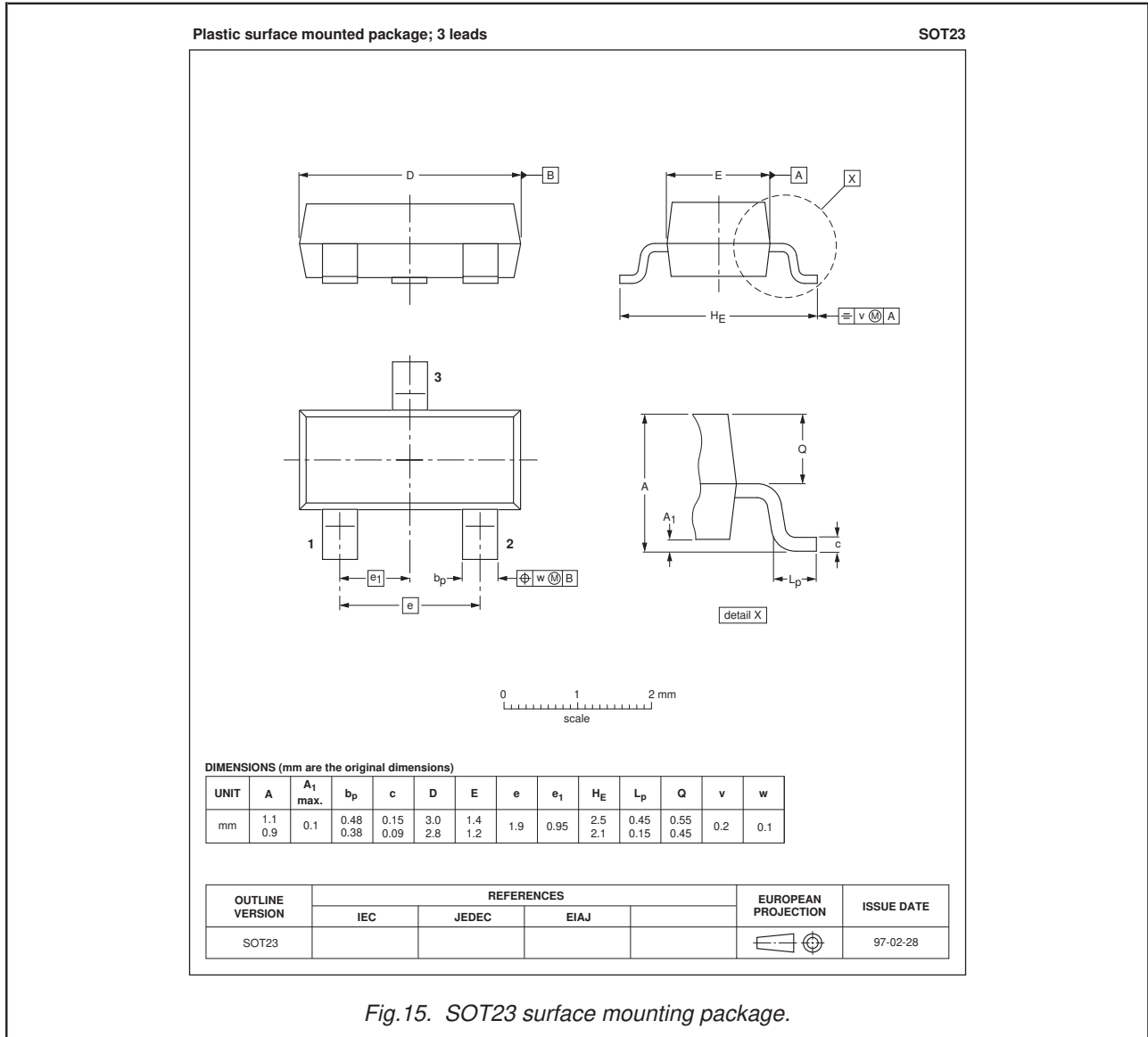


Fig.15. SOT23 surface mounting package.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".